

LED590-03

- Yellow LED
- 590 nm, 4 mW
- Chip: AlGaInP, 350 x 350 μm, 1 pc.
- 5 mm Clear Molding, Epoxy Resin
- Viewing Angle: 30°

Description





Rev. A2

LED590-03 contains one AlGaInP LED chip die with a typical peak wavelength of **590 nm** and radiation power of **4 mW**. It comes in Ø5 mm clear molding package with soldered lead frame (lead free) and lens molded with epoxy resin.

Maximum Ratings (T_{CASE}=25°C)

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Parameter	Symbol	Min.	Max.	Unit
Power Dissipation	PD		120	mW
Forward Current	IF		50	mA
Pulse Forward Current *1	I _{FP}		100	mA
Reverse Voltage	VF		5	V
Thermal Resistance	R _{THJA}		350	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T _{CASE}	- 40	+ 100	°C
Storage Temperature	Tstg	- 40	+ 100	°C
Lead Solder Temperature *2	T _{SLD}		+ 265	°C

*1 duty=1%, pulse width = 10 μ s

*2 must be completed within 5 seconds

Electro-Optical Characteristics (T_{CASE}=25°C)

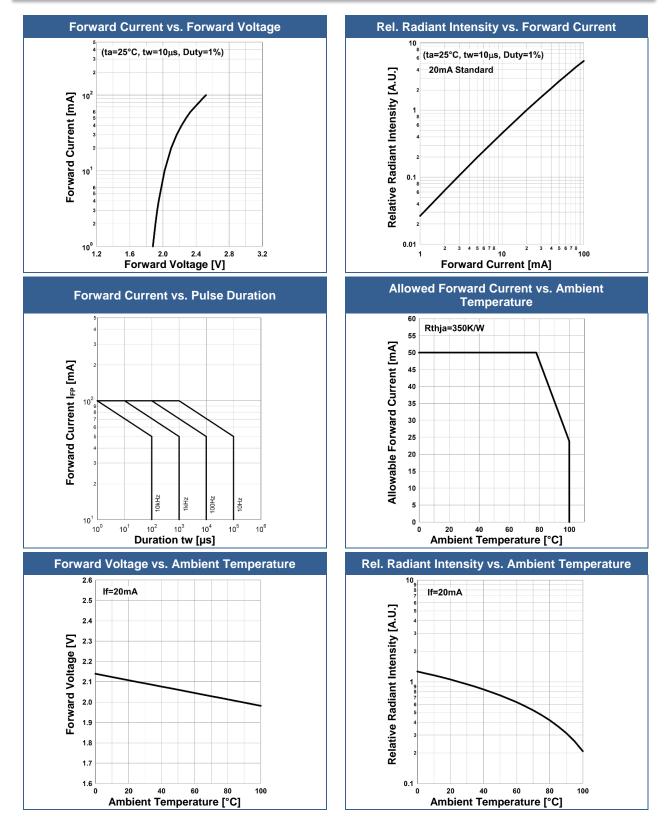
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I⊧=20mA	580		600	nm
Dominant Wavelength	λ_D	I⊧=20mA		586		nm
Half Width	$\Delta \lambda$	I⊧=20mA		13		nm
	VF	I⊧=20mA		2.1	2.3	V
Forward Voltage	VFP	I _{FP} =100mA		2.5		v
Reverse Current	IR	V _R =5V				μA
Radiated Power *1	Po	I _F =20mA I _{FP} =100mA		4.0 21		mW
Radiant Intensity *2	IE	I⊧=20mA I⊧₽=100mA		14 75		mW/sr
Luminous Flux	$\boldsymbol{\phi}_V$	I _F =20mA		2300		mlm
Viewing Angle	20 1/2	I _F =20mA		30		deg.
Rise Time	tr	I _F =20mA		30		ns
Fall Time	tr	I⊧=20mA		25		ns

*1 measured by S3584-08

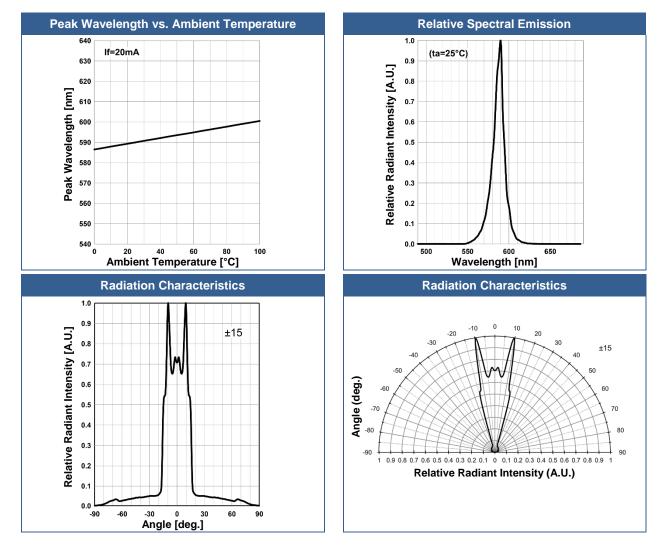
*2 measured by CIE127-2007 Condition B



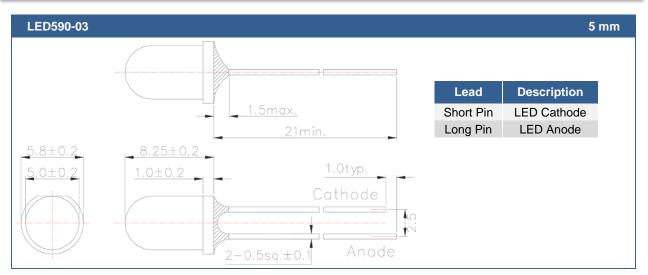
Typical Performance Curves







Outline Dimensions



All Dimensions in mm

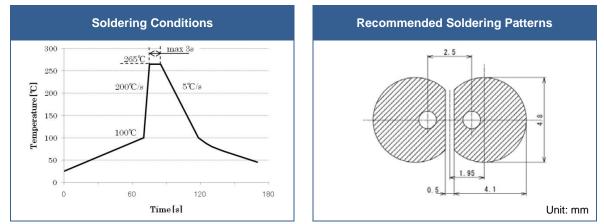


Precautions

Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.



Revisions History

Rel.	Rel. Date	Chapter	Modification	Page
A2	2020-10-19	-	Revised Layout	-
		Typical Performance Curves	included	2-3
A1	2011-04-19	-	Initial release	-

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The above specifications are for reference purpose only and subjected to change without prior notice